



晶采光電科技股份有限公司
AMPIRE CO., LTD.

SPECIFICATIONS FOR LCD MODULE

| | |
|--------------------------|----------------------------|
| CUSTOMER | |
| CUSTOMER PART NO. | |
| AMPIRE PART NO. | AM-1024768JTZQW-00H |
| APPROVED BY | |
| DATE | |

☐ Approved For Specifications

☐ Approved For Specifications & Sample

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|-------------|------------|--------------|
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RECORD OF REVISION

| Revision Date | Page | Contents | Editor |
|---------------|------|----------------------------------|---------|
| 2019/04/01 | -- | New Release | Raymond |
| 2019/06/14 | 10 | Modify Data Input Format, | Tank |
| | 12 | Power ON/OFF Sequence, | |
| | 13 | Luminance Value, Contrast Ratio. | |

1. Features

8 inch Amorphous-TFT-LCD (Thin Film Transistor Liquid Crystal Display) module. This module is composed of a 8" TFT-LCD panel and LED backlight and LED driving board.

- (1) Construction: 8" a-Si TFT active matrix, White LED Backlight.
- (2) Resolution (pixel): 1024(R.G.B) X 768
- (3) Number of the Colors : 16.7M colors (R , G , B 8 bit digital each)
- (4) LCD type :SFT with Normally Black

2. PHYSICAL SPECIFICATIONS

| Item | Specifications | unit |
|---------------------------------|---------------------------------|-------------------|
| LCD size | 8 inch (Diagonal) | |
| Resolution | 1024 x (RGB) x 768 | dot |
| Pixel pitch | 0.158(H) x 0.158(V) | mm |
| Active area | 162.05(W) x 121.54(H) | mm |
| Module size | 183.43(W) x 138.35(H) x 3.75(D) | mm |
| Surface treatment(Up Polarizer) | HC | |
| Color arrangement | RGB-stripe | |
| Contrast Ratio | 1200:1 | |
| Brightness | 460 | cd/m ² |
| Driver IC | RM51150+HX8684B | |

3. ABSOLUTE MAX. RATINGS

3.1 TFT Absolute Maximum Ratings

| Item | Symbol | Values | | UNIT | Note |
|-----------------------------|--------|--------|------|------------------|-----------------|
| | | Min. | Max. | | |
| Power voltage | VCC | -0.3 | 5.0 | V | Note1 |
| | AVDD | -0.5 | 13.5 | | Base on IC Spec |
| | VGH | -0.3 | 42 | | |
| | VGL | VGH-42 | 0.3 | | |
| Operation temperature | TOP | -20 | 70 | °C | |
| Storage temperature | TST | -30 | 80 | °C | |
| Relative Humidity Note 2 | RH | -- | ≤95 | % | Ta≤40°C |
| | | -- | ≤85 | % | 40°C<Ta≤50°C |
| | | -- | ≤55 | % | 50°C<Ta≤60°C |
| | | -- | ≤36 | % | 60°C<Ta≤70°C |
| | | -- | ≤24 | % | 70°C<Ta≤80°C |
| Absolute Humidity | AH | -- | ≤70 | g/m ³ | Ta>70°C |

Note1: Input voltage include RxIN0±, RxIN1±, RxIN2± and RxCLKI±.

Note2: Ta means the ambient temperature.

It is necessary to limit the relative humidity to the specified temperature range.

Condensation on the module is not allowed.

4. ELECTRICAL CHARACTERISTICS

4-1 Typical Operation Conditions

AGND=GND=0V, Ta=25°C

| Item | Symbol | Min | Typ. | Max | Unit | Remark |
|------------------------|--------|------|------|------|------|--------|
| Digital Supply Voltage | DVDD | 3 | 3.3 | 3.6 | V | - |
| Analog Supply Voltage | AVDD | 12.4 | 12.6 | 12.8 | V | - |
| Gate On Voltage | VGH | 22 | 23 | 24 | V | - |
| Gate Off Voltage | VGL | -7.5 | -7 | -6.5 | V | - |

4-2 Power Consumption

AGND=GND=0V, Ta=25°C

| Item | Symbol | Condition | Min | Typ. | Max | Unit | Remark |
|------------------------|-----------------|------------|-----|------|-----|------|--------|
| Digital Supply Current | IVCC | DVDD=3.3V | - | TBD | - | mA | - |
| Analog Supply Current | IAVDD | AVDD=12.6V | - | TBD | - | mA | - |
| Gate On Current | IVGH | VGH=23.0V | - | TBD | - | mA | - |
| Gate Off Current | IVGL | VGL=-7.0V | - | TBD | - | mA | - |
| Power Consumption | Panel I & Gamma | | - | TBD | - | mW | - |

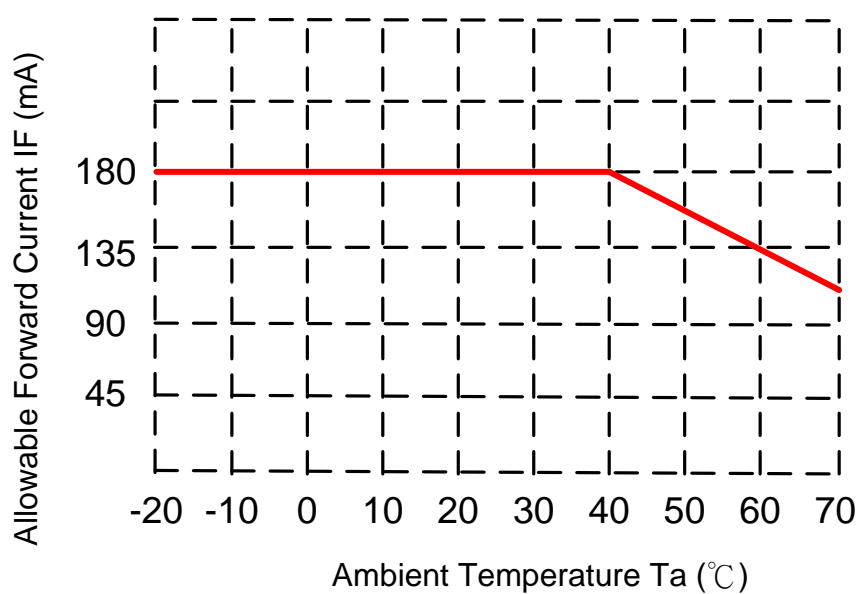
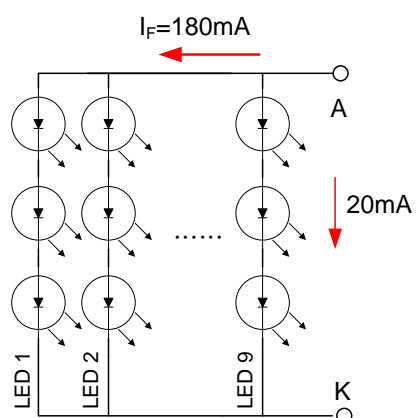
Note1: Checkered Black pattern for Typ.

4-3 LED Driving Conditions

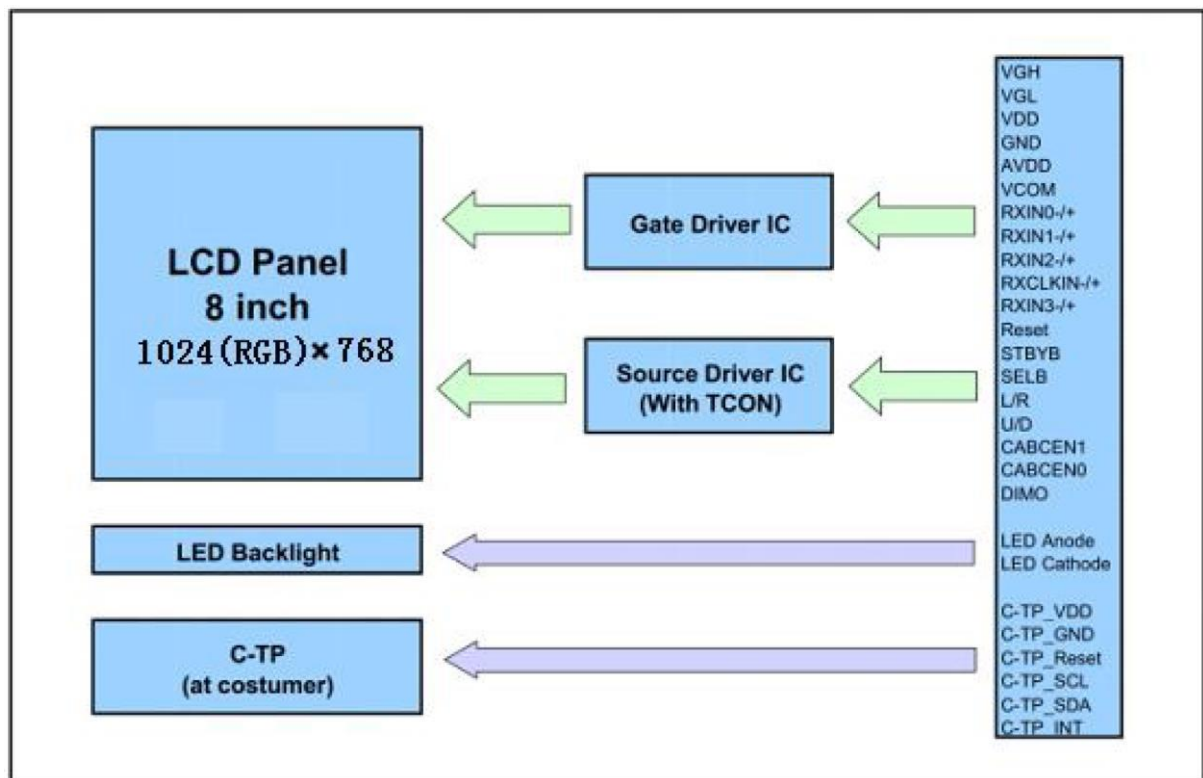
| Item | Symbol | Values | | | Unit | Note |
|---------------------|----------|--------|-------|-------|------|--------------------------|
| | | Min. | Typ. | Max. | | |
| LED voltage | V_F | 8.4 | 9.3 | 10.2 | V | Note(1) |
| LED forward Current | I_F | -- | 180 | 225 | mA | $T_a=25^{\circ}\text{C}$ |
| Power Consumption | W_{BL} | -- | 1.674 | 2.295 | W | |
| LED life time | -- | 20 | 30 | -- | kHr | $I_F=20\text{mA}$ |

Note (1) The constant current source is needed for white LED back-light driving.

Note (2) Brightness to be decreased to 50% of the initial value. $T_a=25^{\circ}\text{C}$



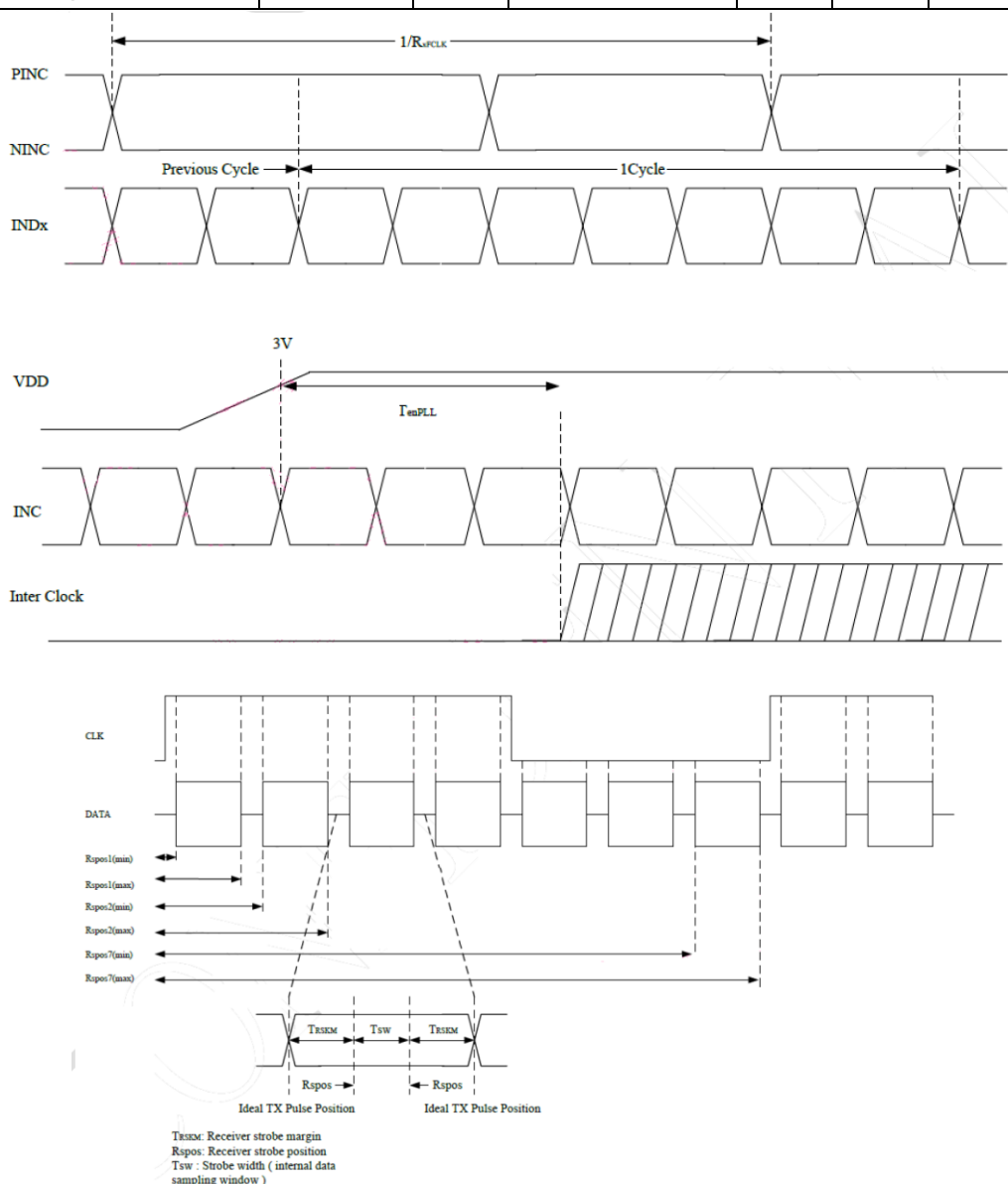
4-4 Block Diagram



5. Timing Chart

5.1 AC Electrical Characteristics

| Parameter | Symbol | Min | Typ | Max | Unit | Conditions |
|------------------------|-------------|-----|--------------------|-----|------|--|
| Clock Frequency | R_{xCLK} | 20 | - | 71 | MHz | |
| Input data skew margin | T_{RSKM} | 500 | - | - | ps | $ VID =400mV$, $R_{xVCM}=1.2V$ $R_{xCLK}=71MHz$ |
| Clock high time | T_{LVCH} | - | $4/(7 * R_{xCLK})$ | - | ns | |
| Clock low time | T_{LVCL} | - | $3/(7 * R_{xCLK})$ | - | ns | |
| PLL wake-up time | T_{enPLL} | - | - | 150 | us | |

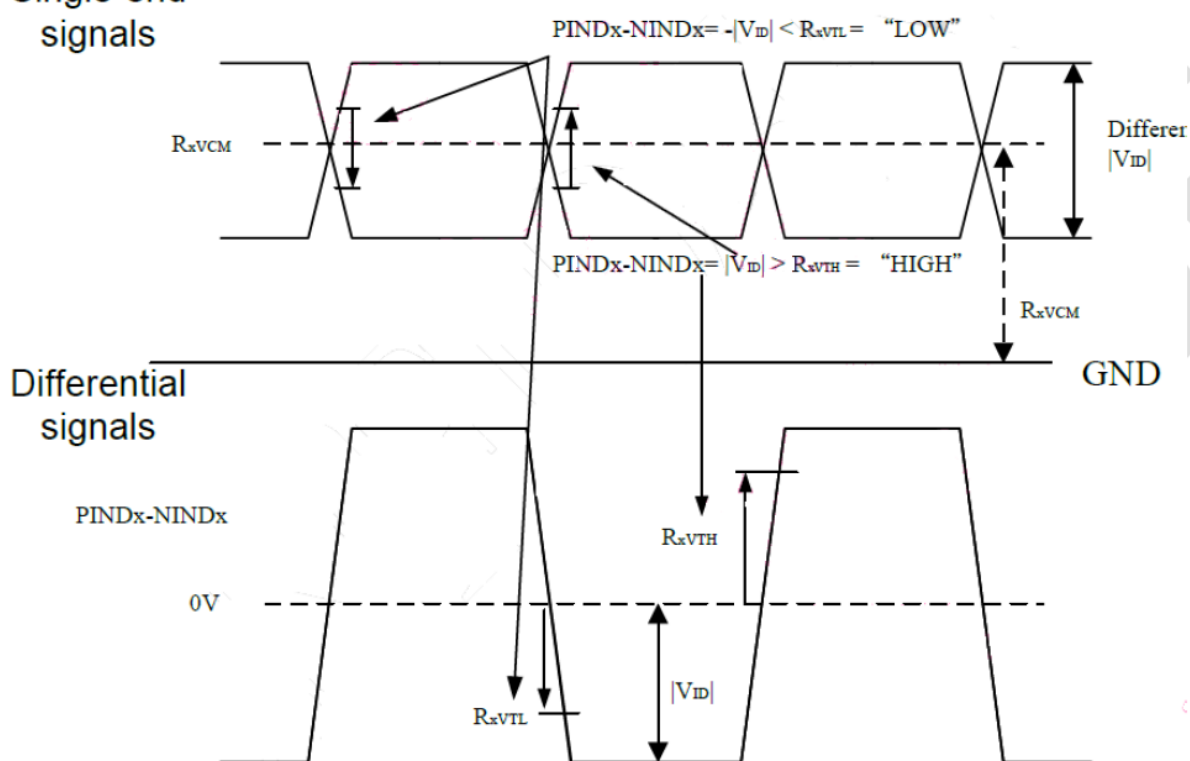


| Parameter | Symbol | Min | Typ | Max | Unit | Conditions |
|----------------------|------------|-----|-----|------|------|--------------------------------|
| Modulation Frequency | SSC_{MF} | 23 | - | 93 | kHz | |
| Modulation Rate | SSC_{MR} | - | - | +/-3 | % | LVDS spread clock=71MHz center |

5.2 DC Electrical Characteristics

| Parameter | Symbol | Min | Typ | Max | Unit | Remark |
|---|-------------|--------------|-----|----------------------|---------|-----------------------------------|
| Differential input high Threshold voltage | R_{XVTH} | – | – | 0.2 | V | $R_{XVCM}=1.2V$ |
| Differential input Low Threshold voltage | R_{XVTL} | -0.2 | – | – | V | |
| Input voltage range (singled-end) | R_{XVIN} | 0 | – | $VDD-1.2$ | V | |
| Differential input common mode voltage | R_{XVCM} | $ V_{ID} /2$ | – | $VDD-1.2- V_{ID} /2$ | V | |
| Differential input voltage | $ V_{ID} $ | 0.2 | – | 0.6 | V | |
| Differential input leakage Current | RV_{XliZ} | -10 | – | 10 | μA | |
| LVDS Digital Operating Current | I_{ddlvs} | – | 15 | 30 | mA | $F_{clk}=65MHz, VDD=3.3V$ |
| LVDS Digital Stand-by Current | I_{stlvs} | – | 10 | 50 | μA | Clock & all functions are stopped |

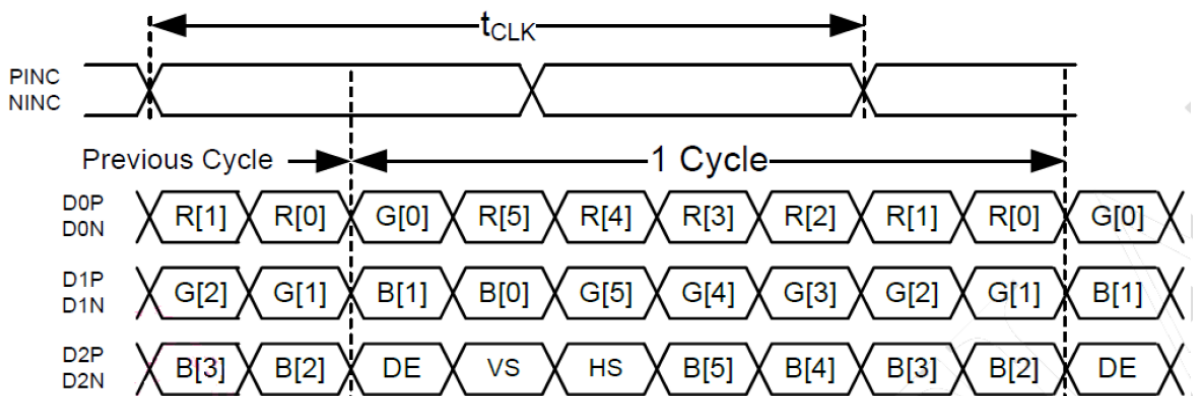
Single-end signals



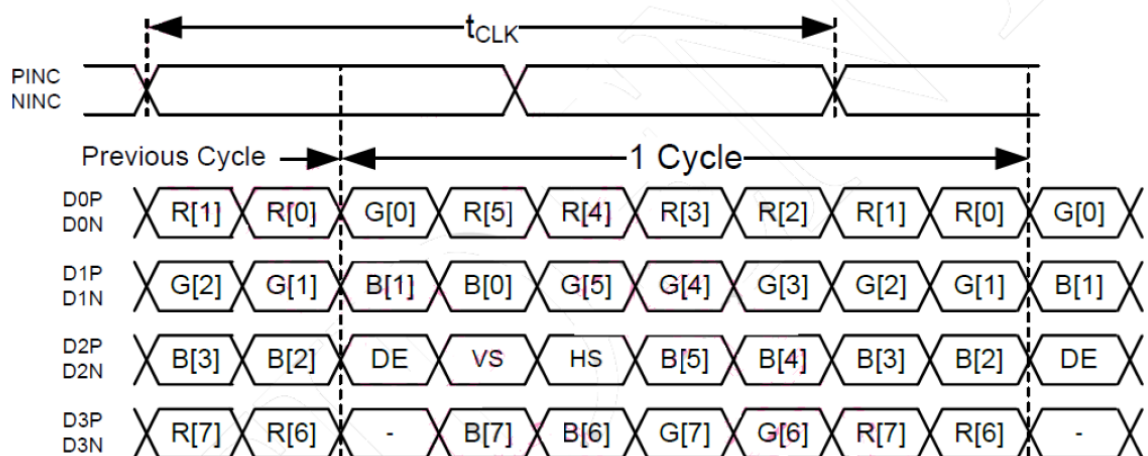
5.3 Data input format

5.3.1 LVDS data mapping

6-bit LVDS input (SELB= "H")



8-bit LVDS input (SELB= "L")



5.3.2 Parallel RGB input timing table

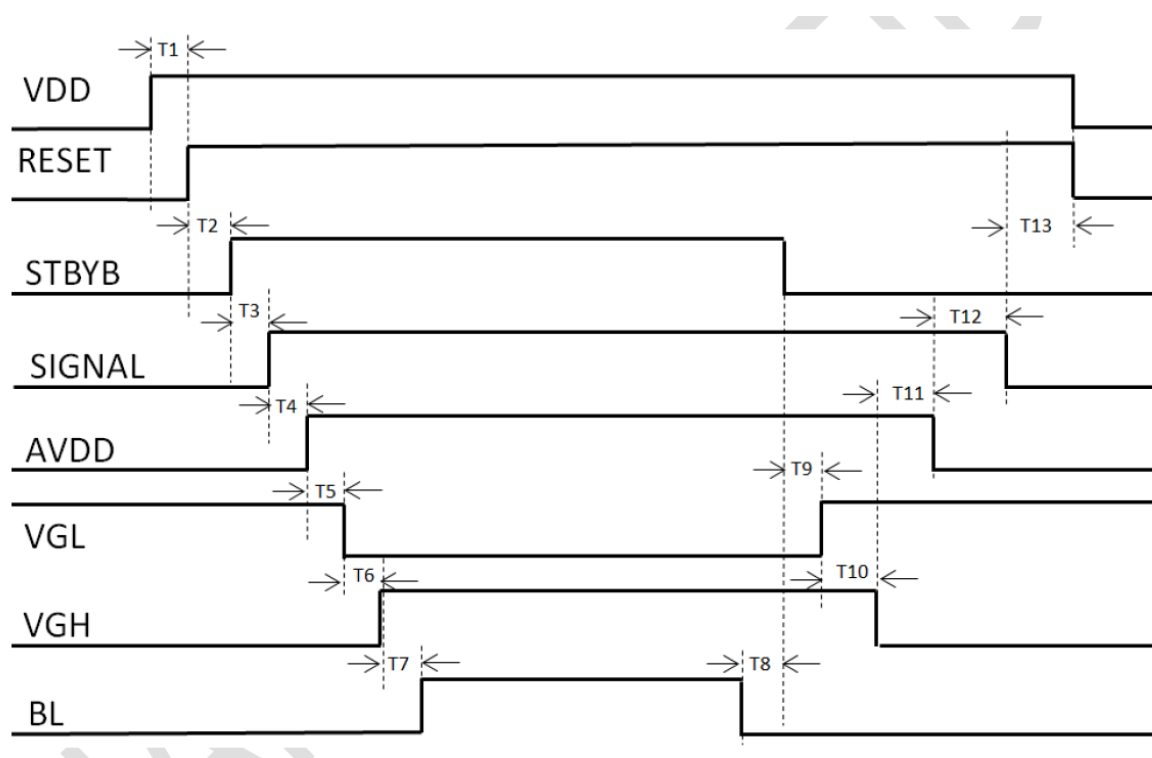
● DE mode

| Parameter | Symbol | Value | | | Unit |
|-------------------------|-----------|-------|------|------|----------------|
| | | Min. | Typ. | Max. | |
| DCLK frequency | fclk | 52 | 65 | 71 | MHz |
| Horizontal Display Area | thd | 1024 | | | DCLK |
| HSD Period | th | 1114 | 1344 | 1400 | DCLK |
| HSD Blanking | thb+thfp | 90 | 320 | 376 | DCLK |
| Vertical display area | tvd | 768 | | | T _H |
| VSD period | tv | 778 | 806 | 845 | T _H |
| VSD Blanking | tvbp+tvfp | 10 | 38 | 77 | T _H |

DE mode(1024x768)

5.4 Power ON/OFF Sequence

| Item | Symbol | Min | Typ. | Max | Unit |
|---|--------|------|------|-----|------|
| VDD on to Reset signal | T1 | 1 | - | - | ms |
| Reset to Standby off | T2 | 0 | - | - | |
| Standby off to Display signal on | T3 | 1 | - | - | |
| Display signal to AVDD on | T4 | 33.2 | - | - | |
| AVDD on to VGL on | T5 | 16.6 | - | - | |
| VGL on to VGH on | T6 | 16.6 | - | - | |
| VGH on to B/L on | T7 | 200 | - | - | |
| B/L off to Standby on | T8 | 500 | - | - | |
| Standby on to VGL off | T9 | 33.2 | - | - | |
| VGL off to VGH off | T10 | 16.6 | - | - | |
| VGH off to AVDD off | T11 | 16.6 | - | - | |
| AVDD off to Display signal off | T12 | 16.6 | - | - | |
| Display signal off to VDD and Reset off | T13 | 16.6 | - | - | |



6. Optical Specifications

6.1 TFT Optical Characteristics

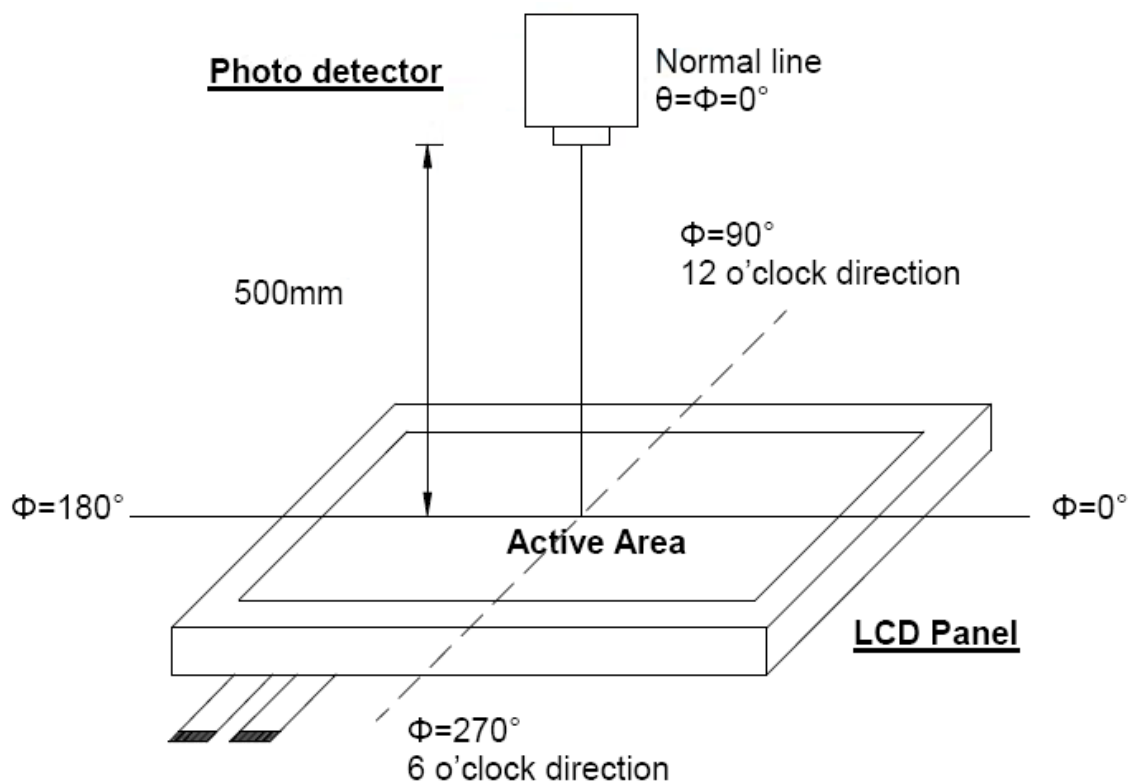
| Item | | Symbol | Condition | Min | Typ | Max | Unit | Remark |
|----------------|-------|------------------|-----------|-------|-------|-------|-------------------|--------------------------------|
| View Angles | | θT | CR≥10 | 75 | 85 | - | Degree | Note 2 |
| | | θB | | 75 | 85 | - | | |
| | | θL | | 75 | 85 | - | | |
| | | θR | | 75 | 85 | - | | |
| Contrast Ratio | | CR | θ=0° | 1500 | 1800 | - | | Left/right 0° Top/bottom 5° |
| Response Time | | T _{ON} | 25℃ | - | 35 | 45 | ms | Note1 Note4 |
| | | T _{OFF} | | | | | | |
| Chromaticity | White | x | | -0.05 | 0.310 | +0.05 | | Note5 Note1 |
| | | y | | | 0.329 | | | |
| | Red | x | | | 0.587 | | | |
| | | y | | | 0.330 | | | |
| | Green | x | | | 0.358 | | | |
| | | y | | | 0.586 | | | |
| | Blue | x | | | 0.156 | | | |
| | | y | | | 0.098 | | | |
| | | Uniformity | | | U | | | |
| NTSC | | | | 45 | 50 | - | % | |
| Luminance | | L | | 400 | 460 | - | cd/m ² | Note7 |

Test Conditions:

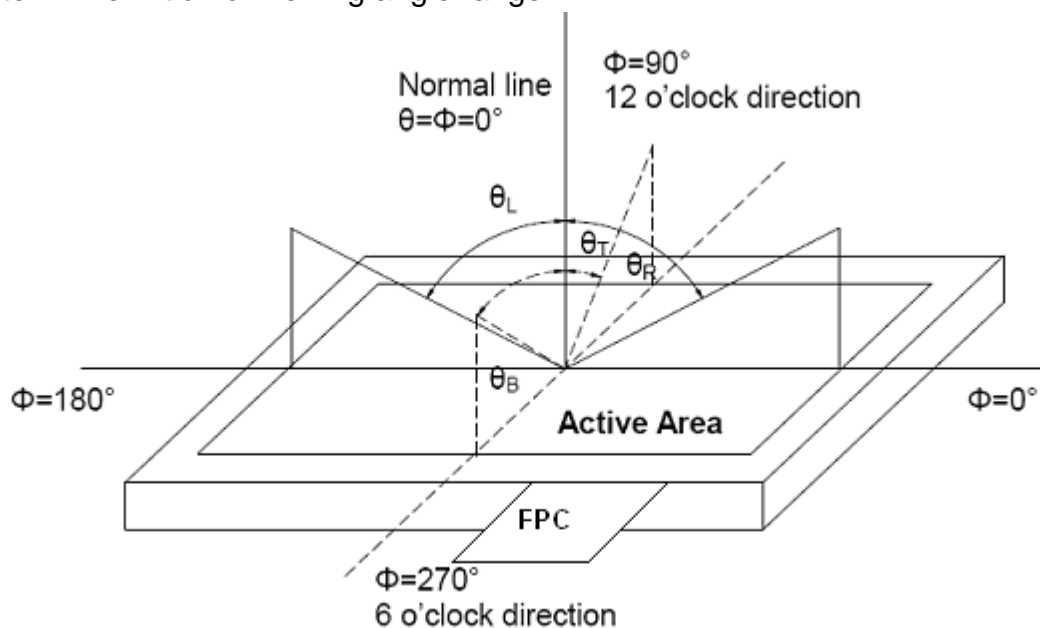
1. $I_F = 180mA$, the ambient temperature is $25^\circ C$.
2. The test systems refer to Note 1 and Note2.

Note 1 : Definition of optical measurement system.

The optical characteristics should be measured in dark room. After 30 minutes operation, the optical properties are measured at the center point of the LCD screen. (Response time is measured by Photo detector TOPCON BM-7, other items are measured by BM-5A/Field of view : 1° / Height : 500mm.)

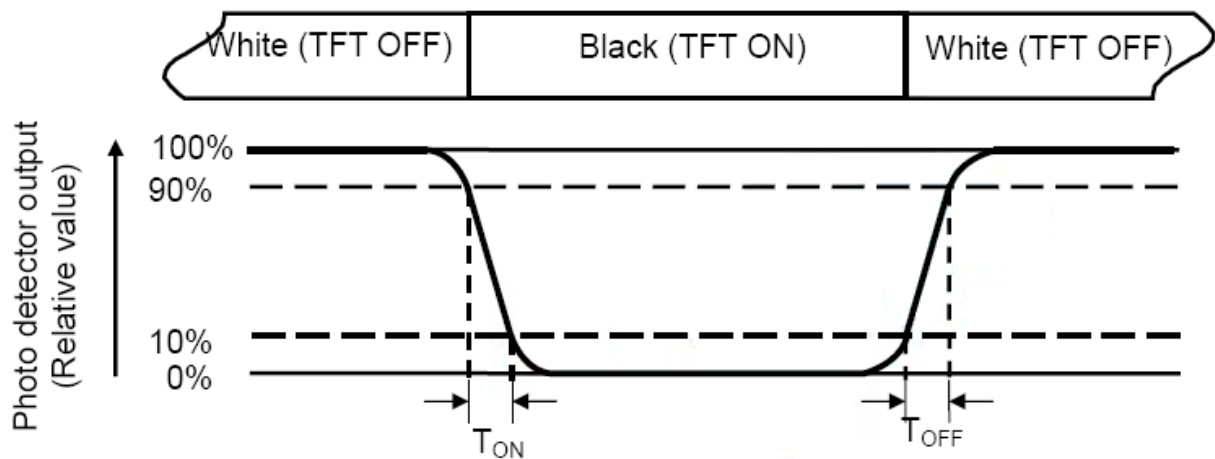


Note 2 : Definition of viewing angle range



Note 3 : Definition of Response time

The response time is defined as the LCD optical switching time interval between "White" state and "Black" state. Rise time (T_{ON}) is the time between photo detector output intensity changed from 90% to 10%. And fall time (T_{OFF}) is the time between photo detector output intensity changed from 10% to 90%.



Note 4 : Definition of contrast ratio

$$\text{Contrast Ratio (CR)} = \frac{\text{Luminance measured when LCD on the "White" state}}{\text{Luminance measured when LCD on the "Black" state}}$$

Note 5 : Definition of color chromaticity (CIE1931)

Color coordinated measured at center point of LCD.

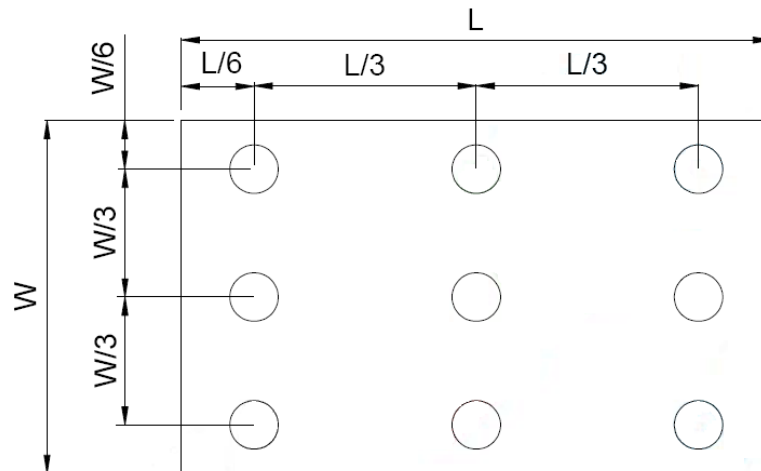
Note 6 : All input terminals LCD panel must be ground when measuring the center area of the panel.

Note 7 : Definition of Luminance Uniformity

Active area is divided into 9 measuring areas (Refer to bellow figure). Every measuring point is placed at the center of each measuring area.

$$\text{Luminance Uniformity}(Y_u) = \frac{B_{min}}{B_{max}}$$

L ----- Active area length W ----- Active area width



B_{max} : The measured maximum luminance of all measurement position.

B_{min} : The measured minimum luminance of all measurement position.

7. INTERFACE

| Pin No | Symbol | I/O | Function | Remark |
|--------|----------|-----|---|--|
| 1 | NC | - | No connection | |
| 2 | VDD | P | Power Voltage for digital circuit | |
| 3 | VDD | P | Power Voltage for digital circuit | |
| 4 | NC | --- | No connection | |
| 5 | Reset | I | Global reset pin | |
| 6 | STBYB | I | Standby mode, Normally pulled high STBYB = "1", normal operation STBYB = "0", timing controller, source driver will turn off, all output are GND | |
| 7 | GND | P | Ground | |
| 8 | RXIN0- | I | - LVDS differential data input | |
| 9 | RXIN0+ | I | + LVDS differential data input | R[0]~G[0] |
| 10 | GND | P | Ground | |
| 11 | RXIN1- | I | - LVDS differential data input | |
| 12 | RXIN1+ | I | + LVDS differential data input | G[1]~B[1] |
| 13 | GND | P | Ground | |
| 14 | RXIN2- | I | - LVDS differential data input | |
| 15 | RXIN2+ | I | + LVDS differential data input | DE/VS/HS/ B[2]~B[5] |
| 16 | GND | P | Ground | |
| 17 | RXCLKIN- | I | - LVDS differential clock input | |
| 18 | RXCLKIN+ | I | + LVDS differential clock input | |
| 19 | GND | P | Ground | |
| 20 | RXIN3- | I | - LVDS differential data input | |
| 21 | RXIN3+ | I | + LVDS differential data input | R[6]/R[7]/ G[6]/G[7]/ B[6]/ B[7] |
| 22 | GND | P | Ground | |
| 23 | NC | --- | No connection | |
| 24 | NC | --- | No connection | |
| 25 | GND | P | Ground | |
| 26 | NC | --- | No connection | |
| 27 | DIMO | O | Backlight CABC controller signal output | Note1 |
| 28 | SELB | I | 6bit/8bit mode select No | Note2 |
| 29 | AVDD | P | Power for Analog Circuit | |
| 30 | GND | P | Ground | |
| 31 | LED- | P | LED Cathode | |
| 32 | LED- | P | LED Cathode | |
| 33 | L/R | I | Horizontal inversion | Note3 |

| | | | | |
|----|---------|---|----------------------|-------|
| 34 | U/D | I | Vertical inversion N | Note3 |
| 35 | VGL | P | Gate OFF Voltage | |
| 36 | CABCEN1 | I | CABC H/W enable pin | Note4 |
| 37 | CABCEN0 | I | CABC H/W enable pin | Note4 |
| 38 | VGH | P | Gate ON Voltage | |
| 39 | LED+ | P | LED Anode | |
| 40 | LED+ | P | LED Anode | |

I/O----definition, I----Input, O----Output, P----Power, No used I/O pin please fix to GND level

Note1: PWM output after CABC function;

Note2: LVDS mode 6bits/8bits input select pin. If LVDS input data in 6 bits, SELB must be set to high. If LVDS input data in 8 bits, SELB must be set to low.

Note3: When L/R="0", set right to left scan direction, L/R="1" set left to right scan direction. When U/D="0", set top to bottom scan direction, U/D="1" set bottom to top scan direction.

Note4:

CABC_EN 【1 : 0】 CABC H/W enable pin. Normally pull low.

CABC_EN="00", CABC off. (Default mode)

CABC_EN="01", user interface image.

CABC_EN="10", still picture.

CABC_EN="11", moving image.

8. RELIABILITY TEST CONDITIONS

| Test Item | Test Conditions | Note |
|----------------------------|---|------|
| High Temperature Operation | 70±3°C , t=240 hrs | |
| Low Temperature Operation | -20±3°C , t=240 hrs | |
| High Temperature Storage | 80±3°C , t=240 hrs | 1,2 |
| Low Temperature Storage | -30±3°C , t=240 hrs | 1,2 |
| Thermal Shock Test | -30°C ~ 80°C 30 min. ~ 30 min. (1 cycle) Total 100cycle | 1,2 |
| Storage Humidity Test | 60 °C, Humidity 90%, 240 hrs | 1,2 |
| Vibration Test (Packing) | Sweep frequency : 10 ~ 50 ~ 10 Hz/1min Amplitude : 0.75mm Test direction : X.Y.Z/3 axis Duration : 30min/each axis | 2 |

Note 1: Condensation of water is not permitted on the module.

Note 2: The module should be inspected after 1 hour storage in normal conditions (15-35°C, 45-65%RH).

Note 3 : The module shouldn't be tested more than one condition, and all the test conditions are independent.

Note 4 : All the reliability tests should be done without protective film on the module.

Definitions of life end point:

- Current drain should be smaller than the specific value.
- Function of the module should be maintained.
- Appearance and display quality should not have degraded noticeably.
- Contrast ratio should be greater than 50% of the initial value.

9. General Precautions

9.1 Handling Precautions

1. Display panel is made of glass. Do not subject it to a mechanical shock by dropping it from a high place, etc.
2. If the display panel is damaged and the liquid crystal substance inside it leaks out, be sure not to get any in your mouth, if the substance comes into contact with your skin or clothes, promptly wash it off using soap and water.
3. Do not apply excessive force to the display surface or the adjoining areas since this may cause the color tone to vary.
4. The polarizer covering the display surface of the LCD module is soft and easily scratched. Handle this polarizer carefully.
5. If the display surface is contaminated, breathe on the surface and gently wipe it with a soft dry cloth. If still not completely clear, moisten cloth with one of the following solvents:
 - Isopropyl alcohol
 - Ethyl alcoholSolvents other than those mentioned above may damage the polarizer. Especially, do not use the following:
 - Water
 - Ketone
 - Aromatic solvents
6. Do not attempt to disassemble the LCD Module.
7. If the logic circuit power is off, do not apply the input signals.
8. To prevent destruction of the elements by static electricity, be careful to maintain an optimum work environment.
 - a. Be sure to ground the body when handling the LCD Modules.
 - b. Tools required for assembly, such as soldering irons, must be properly ground.
 - c. To reduce the amount of static electricity generated, do not conduct assembly and other work under dry conditions.
 - d. The LCD Module is coated with a film to protect the display surface. Be care when peeling off this protective film since static electricity may be generated.

9.2 Storage precautions

1. When storing the LCD modules, avoid exposure to direct sunlight or to the light of fluorescent lamps.
2. The LCD modules should be stored under the storage temperature range. If the LCD modules will be stored for a long time, the recommend condition is:
Temperature : 0℃ ~ 40℃
Relatively humidity: ≤80%
3. The LCD modules should be stored in the room without acid, alkali and harmful gas.

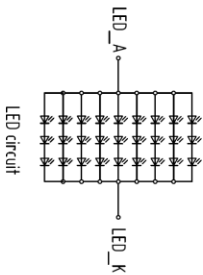
9.3 General Precautions

1. Do not keep the LCD at the same display pattern continually. The residual image will happen and it will damage the LCD. Please use screen saver.
2. The LCD modules should be no falling and violent shocking during transportation, and also should avoid excessive press, water, damp and sunshine.

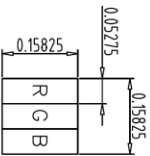
21



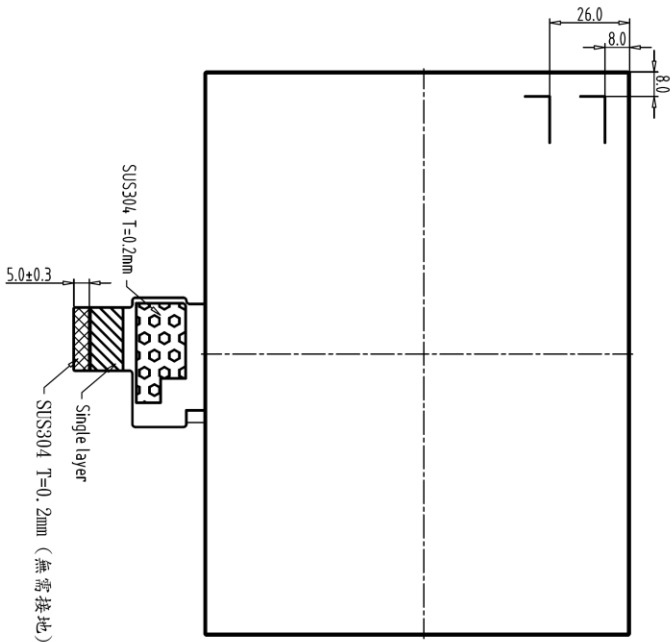
| REV | REVISION RECORD | DATE NAME |
|-----|-----------------|----------------|
| 0 | NEW RELEASE | 02-14-19 MILLY |



| | | | |
|----|----------|----|---------|
| 1 | NC | 21 | RXIN3+ |
| 2 | VDD | 22 | GND |
| 3 | VDD | 23 | NC |
| 4 | NC | 24 | NC |
| 5 | RESET | 25 | GND |
| 6 | STBYB | 26 | NC |
| 7 | GND | 27 | DIMO |
| 8 | RXIN0- | 28 | SELB |
| 9 | RXIN0+ | 29 | AVDD |
| 10 | GND | 30 | GND |
| 11 | RXIN1- | 31 | LED- |
| 12 | RXIN1+ | 32 | LED- |
| 13 | GND | 33 | L/R |
| 14 | RXIN2- | 34 | U/D |
| 15 | RXIN2+ | 35 | VGL |
| 16 | GND | 36 | CABGEN1 |
| 17 | RXCLKIN- | 37 | NC |
| 18 | RXCLKIN+ | 38 | VGH |
| 19 | GND | 39 | LED+ |
| 20 | RXIN3- | 40 | LED+ |



A Block



Back View

- Note:
1. Unless indicated, Tolerance "±0.3".
 2. UV Glue For OLB Protection.
 3. Matched connector: FH12A-40S-0.5SH.

| 1 | 7 | TOLERANCE GRADE(±) | A | B | DIM. | DWN. | DATE | TITLE |
|---|----|--------------------|---|---|----------------|-------|----------|--------------|
| 2 | 8 | | | | MM | MILLY | 02-14-19 | 1024768J |
| 3 | 9 | | | | JE NO. | CHK. | DATE | (8.0") |
| 4 | 10 | | | | PARTS NO LCM-1 | APPD. | DATE | DWG. NO. |
| 5 | 11 | | | | 1024768J | | | *190246MA |
| 6 | 12 | | | | | | | SHEET 1 OF 1 |

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